

**PCN#20240306004.2
Adding FFAB as additional wafer probe (EWS) site
Final Change Notification**

Date: March 06, 2024

To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

Change Management Team
SC Business Services

20240306004.2

Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

| DEVICE | CUSTOMER PART NUMBER |
|-----------------|-----------------------------|
| INA333QDGKRQ1 | NULL |
| OPA2365AQDRQ1 | NULL |
| OPA365AQDBVRQ1 | NULL |
| REF3112AQDBZRQ1 | NULL |
| REF3120AQDBZRQ1 | NULL |
| REF3125AQDBZRQ1 | NULL |
| REF3130AQDBZRQ1 | NULL |
| REF3133AQDBZRQ1 | NULL |
| REF3140AQDBZRQ1 | NULL |
| TMP300BQDCKRQ1 | NULL |

Technical details of this Product Change follow on the next page(s).

| | | | | | |
|---|--|---|--|---|----------------|
| PCN Number: | 20240306004.2 | | | PCN Date: | March 06, 2024 |
| Title: | Adding FFAB as additional wafer probe (EWS) site | | | | |
| Customer Contact: | Change Management team | | Dept: | Quality Services | |
| Proposed 1st Ship Date: | September 02, 2024 | | Sample Requests accepted until: | Samples not supported | |
| Change Type: | | | | | |
| <input type="checkbox"/> Assembly Site | <input type="checkbox"/> | Design | <input type="checkbox"/> | Wafer Bump Material | |
| <input type="checkbox"/> Assembly Process | <input type="checkbox"/> | Data Sheet | <input type="checkbox"/> | Wafer Bump Process | |
| <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> | Part number change | <input type="checkbox"/> | Wafer Fab Site | |
| <input type="checkbox"/> Mechanical Specification | <input checked="" type="checkbox"/> | Test Site | <input type="checkbox"/> | Wafer Fab Material | |
| <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> | Test Process | <input type="checkbox"/> | Wafer Fab Process | |
| PCN Details | | | | | |
| Description of Change: | | | | | |
| Texas Instruments Incorporated has qualified FFAB as additional probe (EWS) site for the devices listed below to support high volume ramps. | | | | | |
| Current: | | New: | | | |
| Probe Site (EWS) | SFAB (SH-BIP) | FFAB (FR-BIP) | | | |
| Test coverage, insertions, conditions will remain consistent with current testing. | | | | | |
| Reason for Change: | | | | | |
| Enable additional probe capacity to support high volume ramps. | | | | | |
| Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative): | | | | | |
| None | | | | | |
| Impact on Environmental Ratings | | | | | |
| Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings. | | | | | |
| RoHS | | REACH | | Green Status | |
| <input checked="" type="checkbox"/> No Change | | <input checked="" type="checkbox"/> No Change | | <input checked="" type="checkbox"/> No Change | |
| IEC 62474 | | | | | |
| <input checked="" type="checkbox"/> No Change | | | | | |
| Changes to product identification resulting from this PCN: | | | | | |
| None | | | | | |
| Product Affected: | | | | | |
| ATOPA2350UA/2K5 | OPA365AQDBVRQ1 | REF3125AQDBZRQ1 | REF3140AQDBZRQ1 | | |
| INA333QDGKRQ1 | REF3112AQDBZRQ1 | REF3130AQDBZRQ1 | TMP300BQDCKRQ1 | | |
| OPA2365AQDRQ1 | REF3120AQDBZRQ1 | REF3133AQDBZRQ1 | | | |

ZVEI ID reference: SEM-TF-01

For questions regarding this notice, e-mails can be sent to Change Management team or your local Field Sales Representative.

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